

Band Offsets At Interfaces of Current Interest

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OUTLINE

Introduction

Band Offset : What is it? Why is it important?

**Conventional Band Offset Theories - Blame it on the
“interface states”**

What's wrong with the “interface states” explanation?

**Let's ask the chemists how to solve this solid state
physicists' problem!**

Implications for Current Technological Interfaces

Metal-organic and organic-organic interfaces

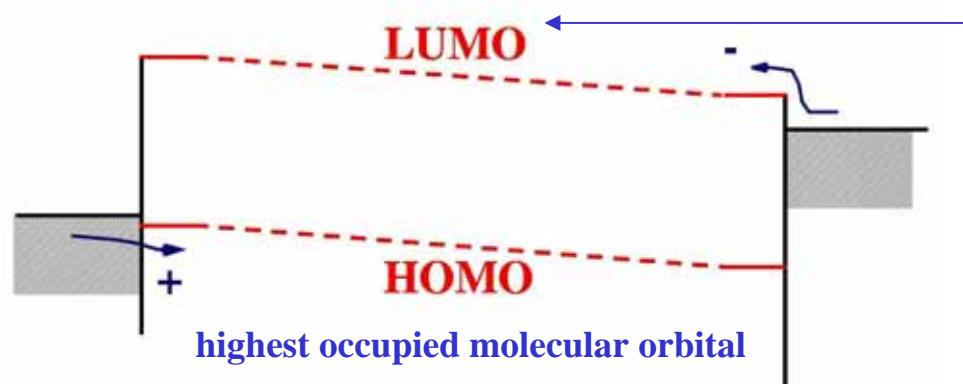
High-K Oxide/Si interfaces

Material Interfaces of Current Interest

Anode

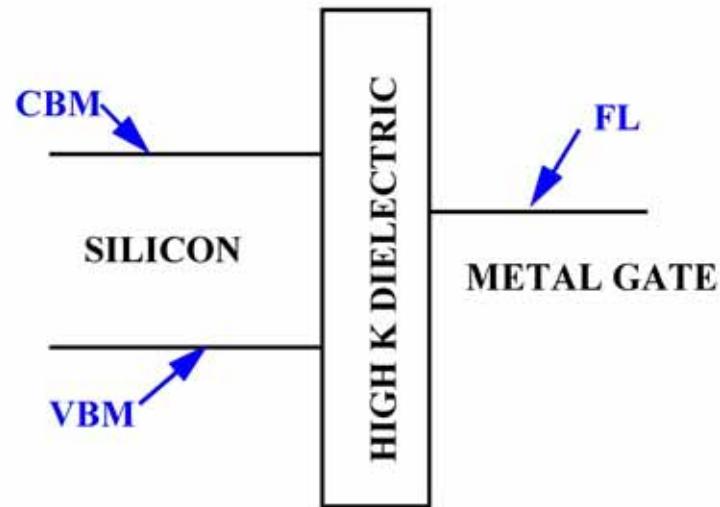
Organic

Cathode

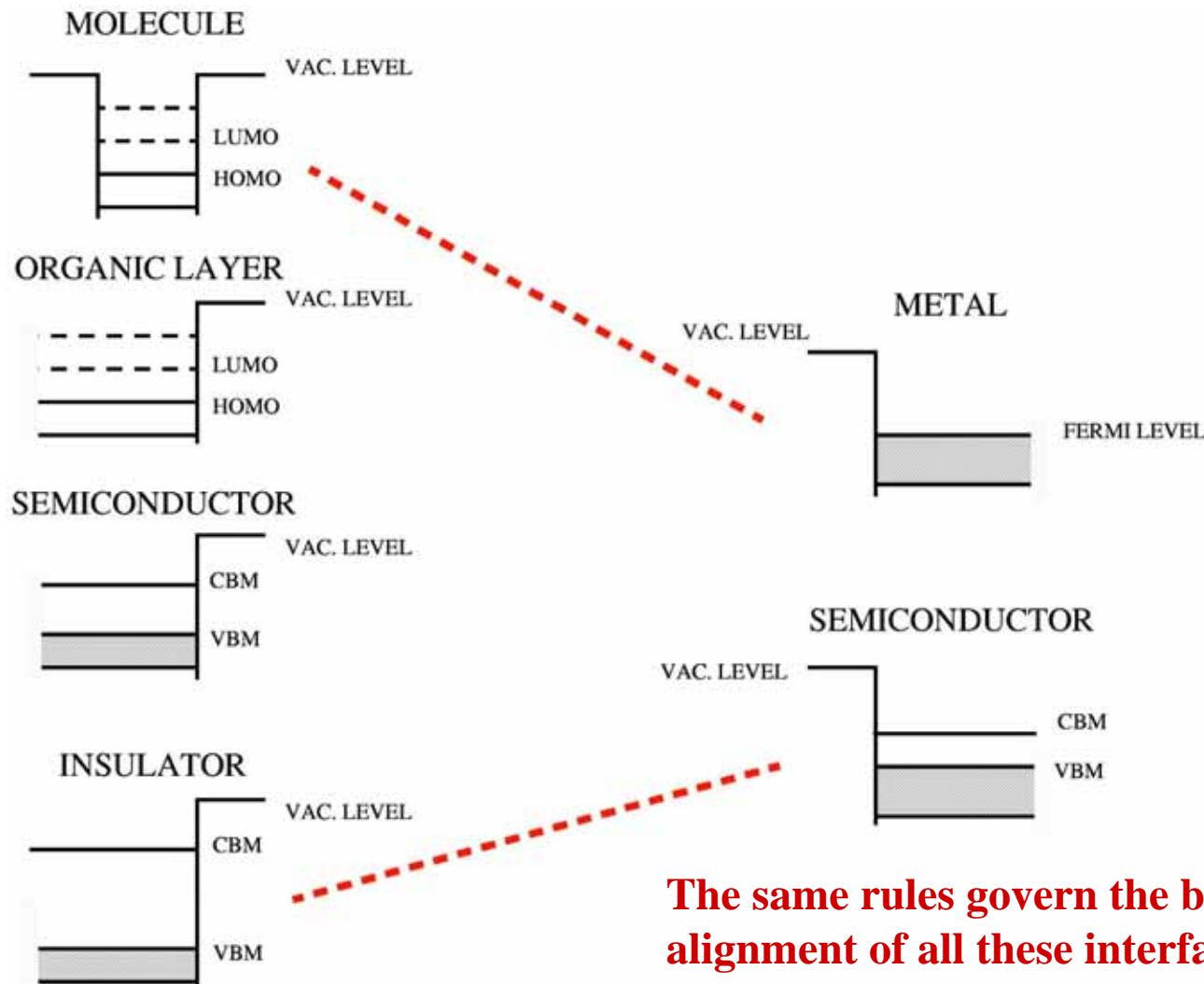


“Organic LE Device”

MOSFET with
High K Insulator

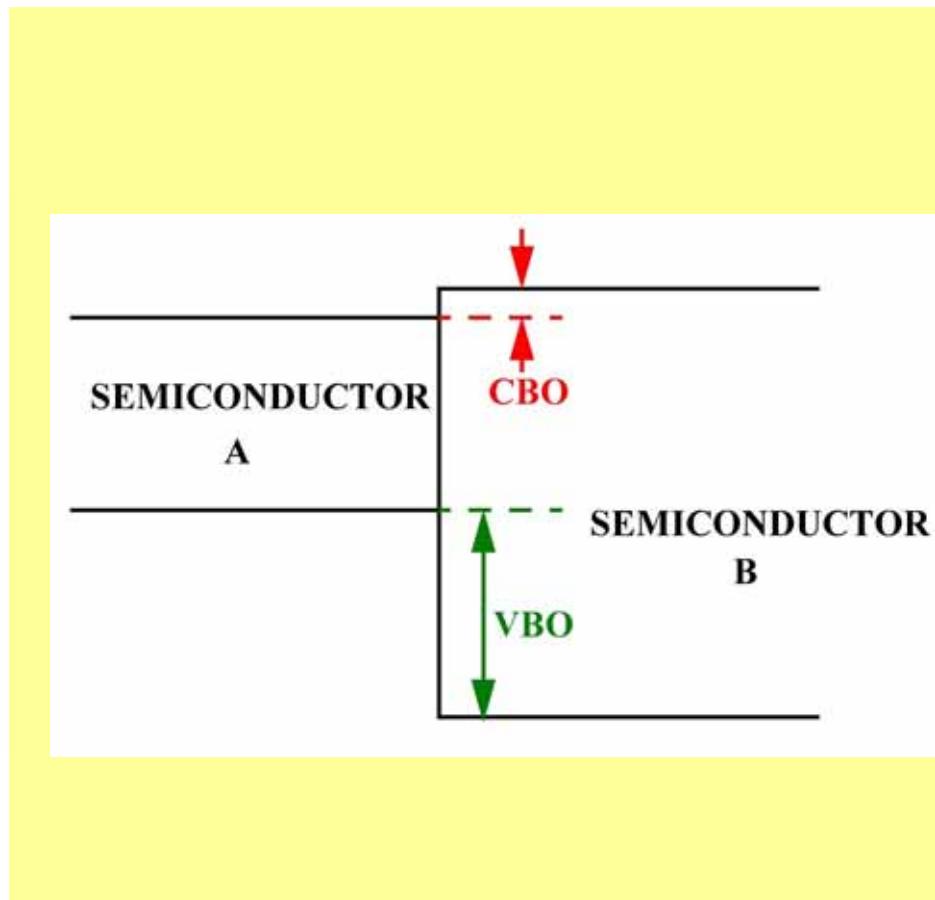
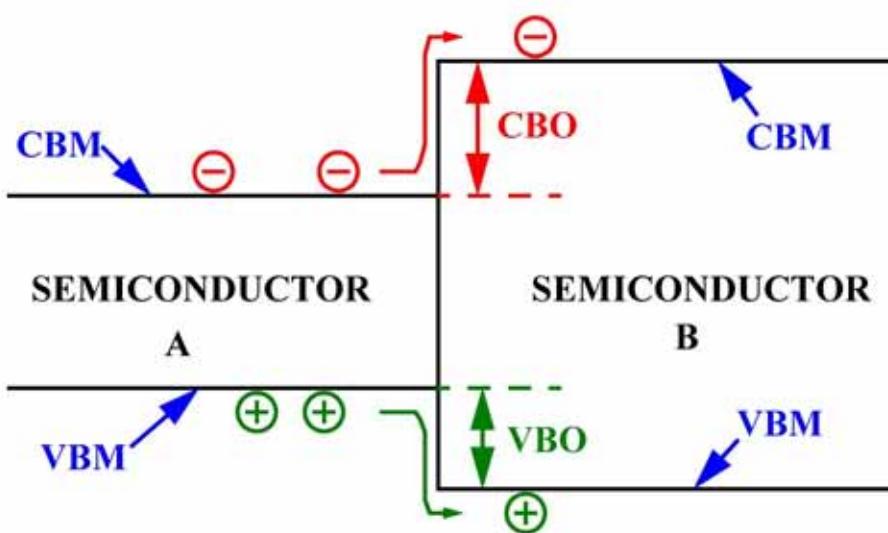


Band Alignment (Offset) Problem



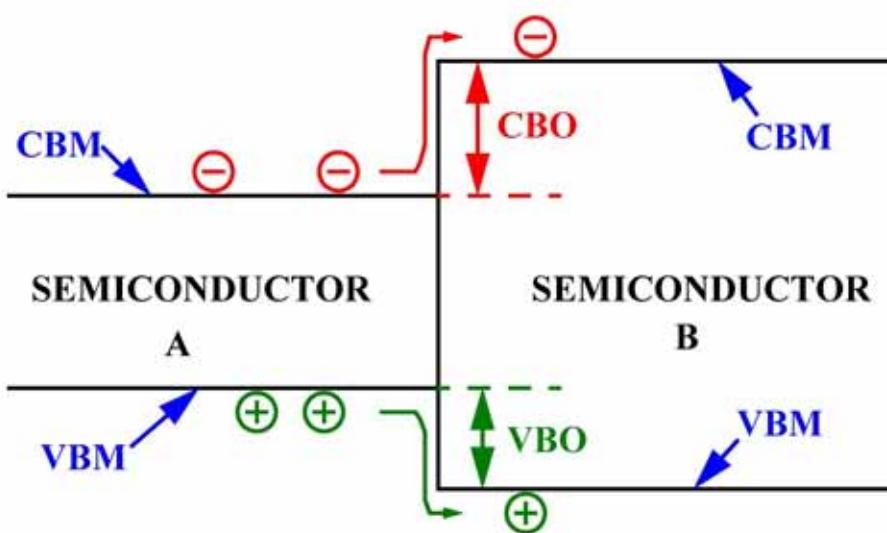
Band Offset and Schottky Barrier Height

Semiconductor Heterojunction

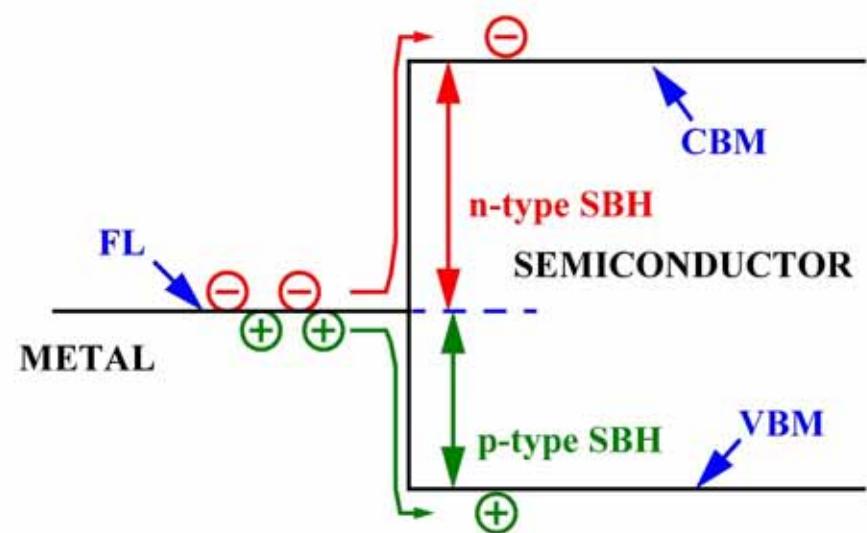


Band Offset and Schottky Barrier Height

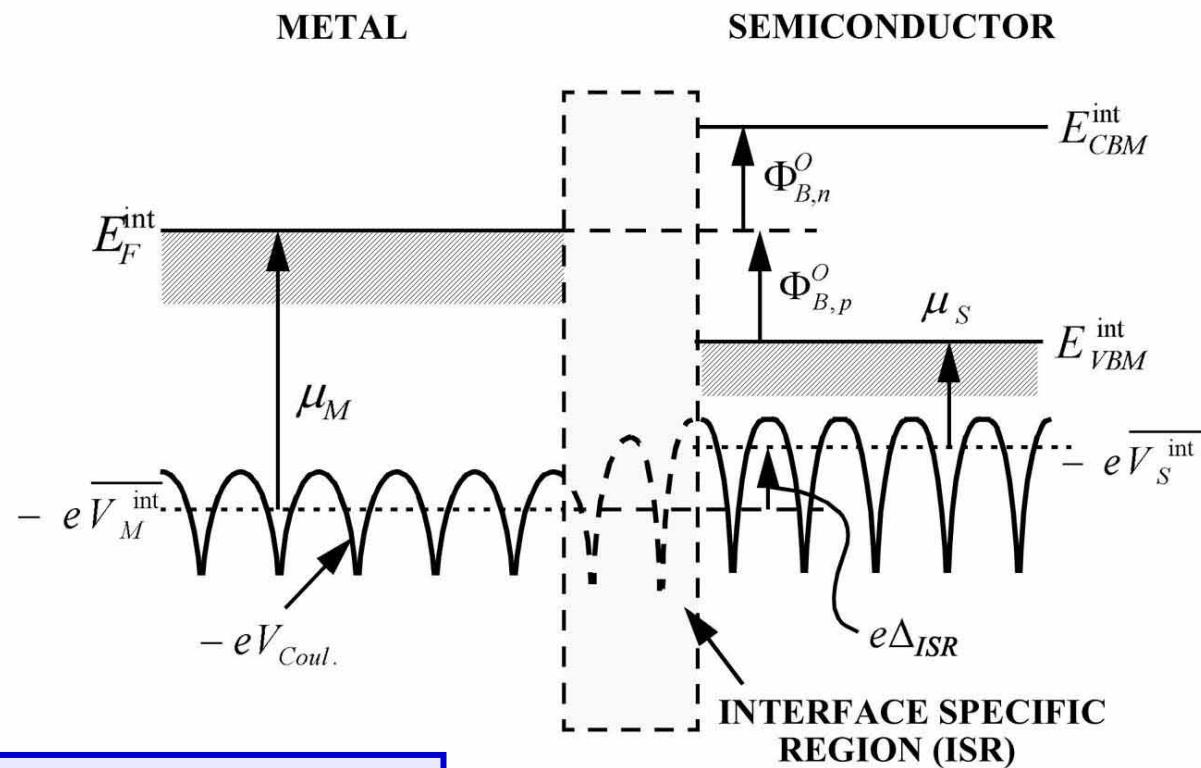
Semiconductor Heterojunction



Schottky Barrier



Electrostatic Potential And Schottky Barrier Height



$$\Phi_{B,p}^O = \mu_M - \mu_S - e\Delta_{ISR}$$

bulk terms

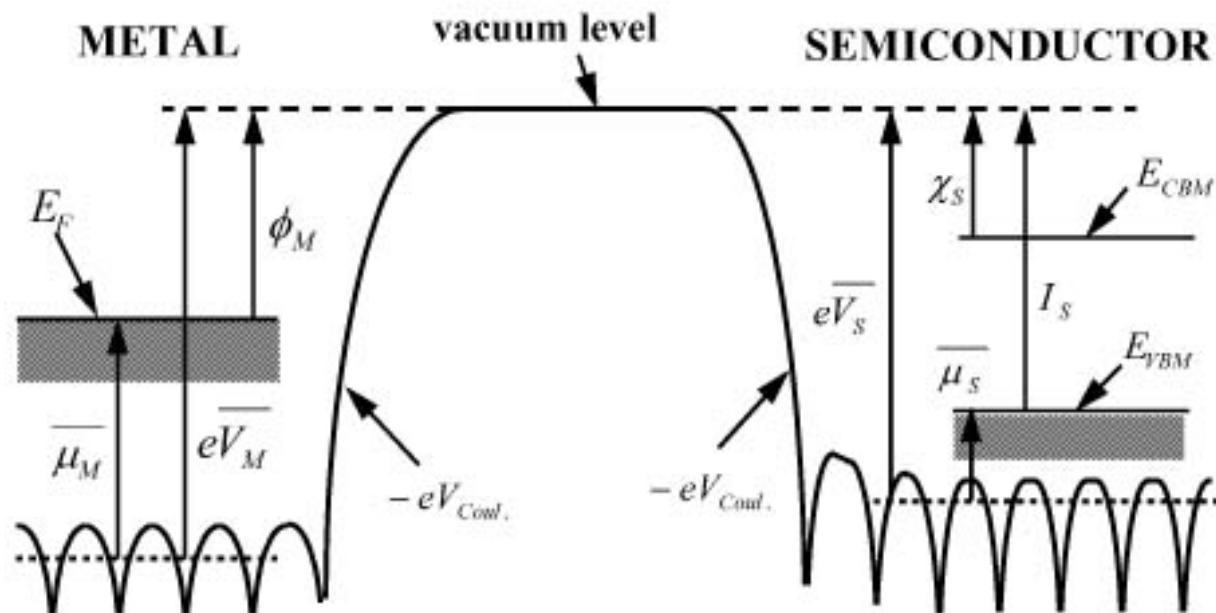
interface term

Inside the ISR:

- (1) Electrostatic potential is continuous
- (2) Charge distribution is such that the interface energy is minimized

The “Schottky-Mott” Relationship

“ISOLATED METAL AND SEMICONDUCTOR”



Schottky-Mott Relationship

$$\Phi_{B,n}^o = \phi_M - \chi_s$$

↑
n-SBH ↑
metal w.f.

= “FREEZE THE CHARGE DISTRIBUTION”

semiconductor electron affinity

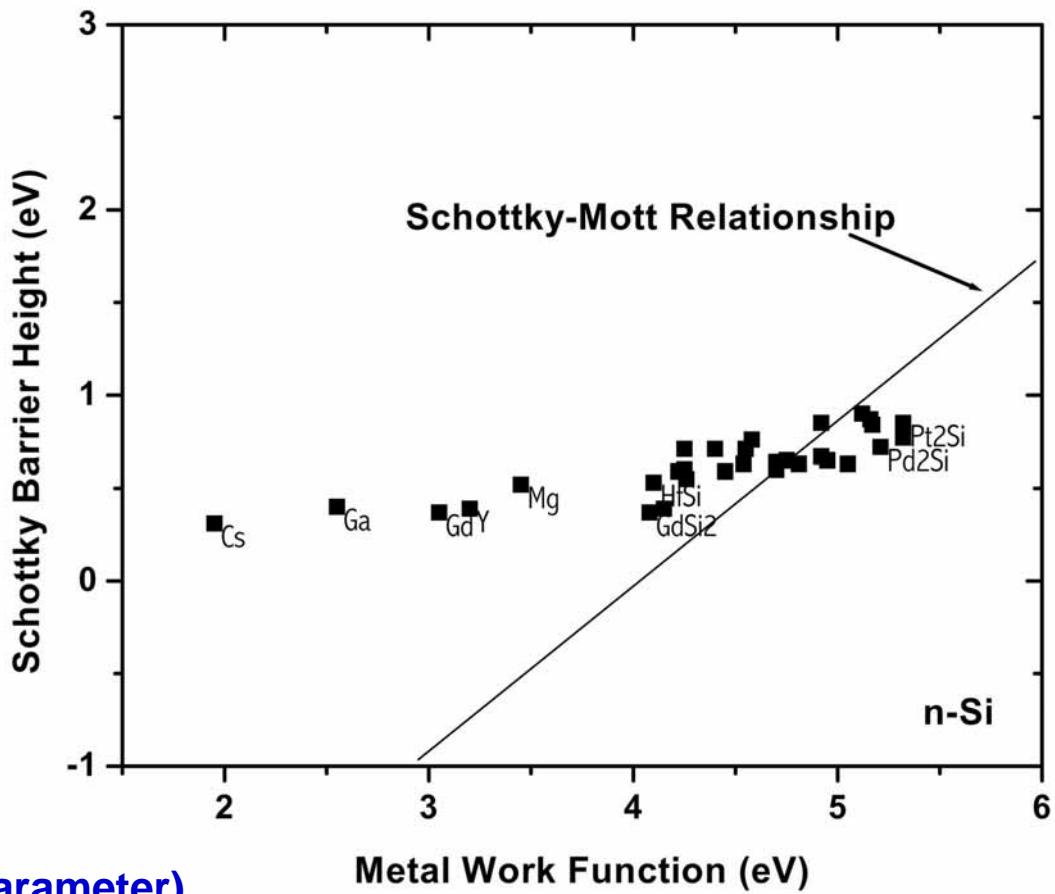
The Fermi Level Pinning Phenomenon

Schottky-Mott Prediction

$$S_{\Phi} \equiv \frac{\partial \Phi_{B,n}^o}{\partial \phi_M} = 1$$

Experimental Observation

$$S_{\Phi} \approx 0.1 - 0.3$$



Interface behavior parameter (S-parameter)
reflects how strongly the SBH depends on
the metal (work function).

Interface Chemistry

**Non-Interactive
Schottky-Mott Model:**

$$\Phi_{B,n}^o = \phi_M - \chi_S$$

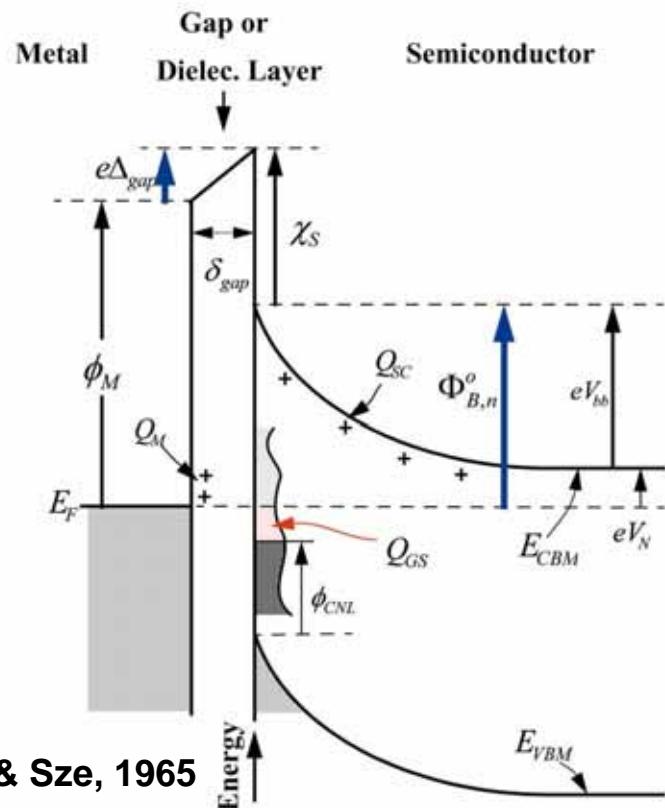
**FL pinning suggests
Interface Interaction:**

$$\Phi_{B,n}^o = \phi_M - \chi_S + e\Delta_{gap}$$



interface dipole

Interface Gap States: Fixed-Separation Model



Cowley & Sze, 1965

$$\Phi_{B,n}^o = \phi_M - \chi_S + e\Delta_{gap}$$

||

$$(\phi_{CNL} - \Phi_{B,n}^o) \frac{e^2 D_{gs} \delta_{gap}}{\epsilon_{gap}}$$

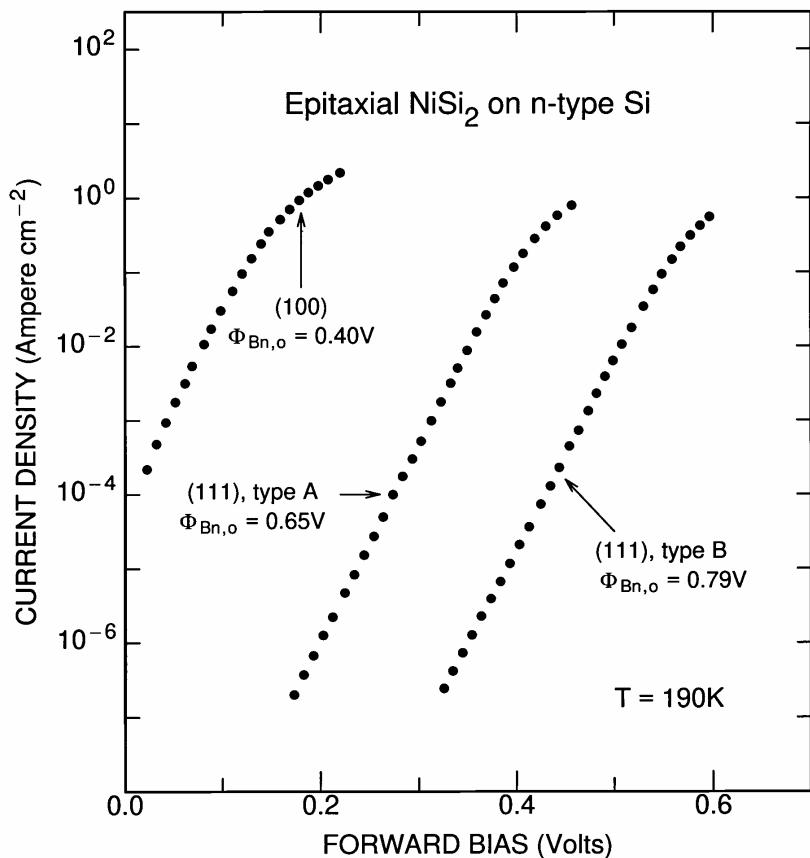
$$\Phi_{B,n}^o = \gamma_{GS} (\phi_M - \chi_S) + (1 - \gamma_{GS}) (E_g - \phi_{CNL})$$

$$\gamma_{GS} = \left(1 + e^2 \delta_{gap} D_{GS} \epsilon_{gap}^{-1} \right)^{-1} \quad \longleftrightarrow \quad S_\Phi$$

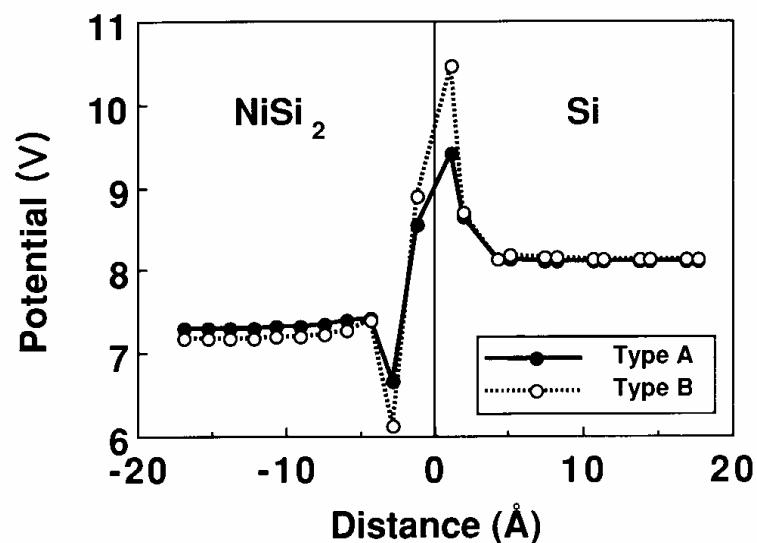
Conditions for systematic analysis:

- (1) Interface states are independent of the metal.
- (2) Interface gap (distance) is large, $> 1\text{nm}$.

Single Crystal Schottky Barriers



Ab initio calculations reproduced the experimental A-B difference



Schottky barrier height depends on interface structure !

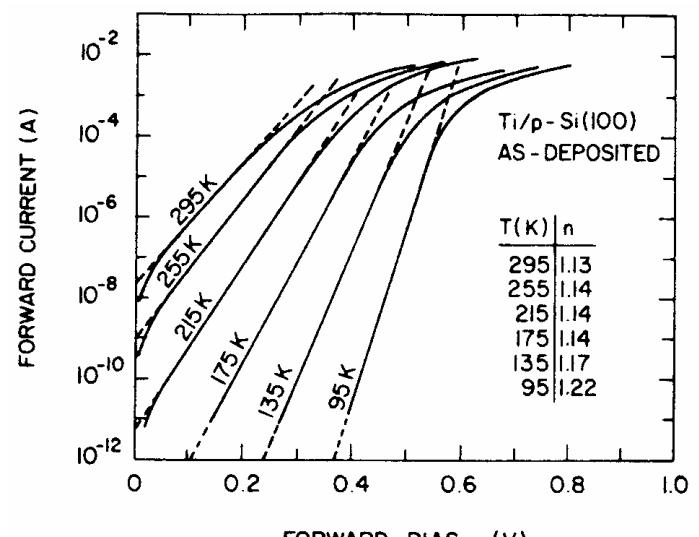
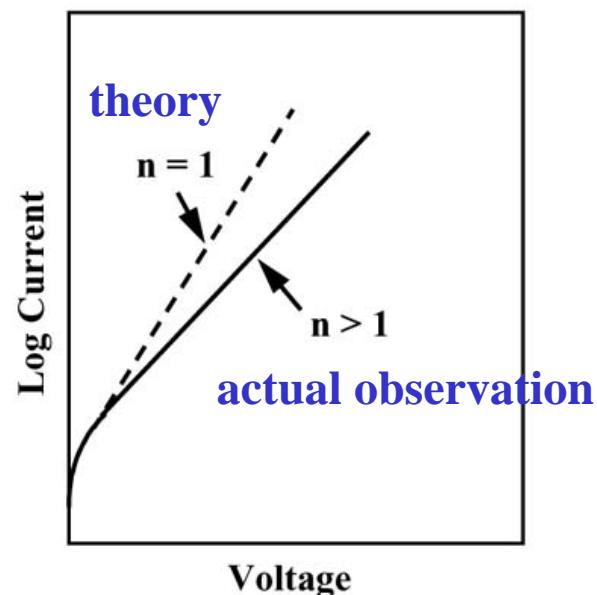
Fujitani and Asano 1990

Ideality Factor

Thermionic Emission Theory

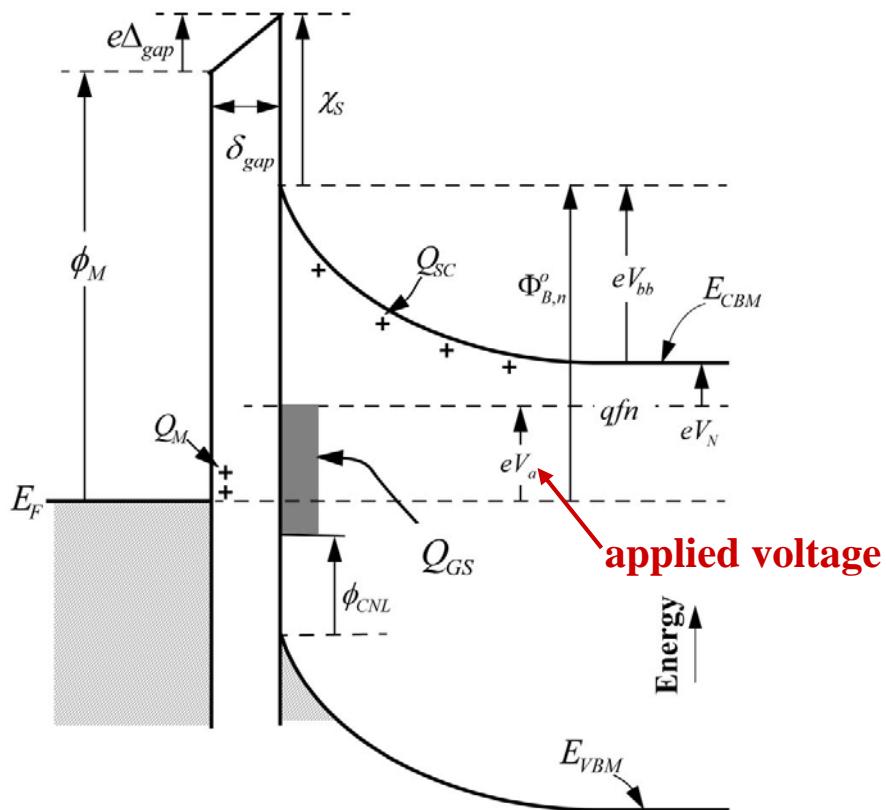
$$I_{SB}(V_a) = AA^*T^2 \exp\left(-\frac{e\Phi_{B,n}}{k_B T}\right) \left[\exp\left(\frac{eV_a}{nk_B T}\right) - 1 \right]$$

n: ideality factor



Aboelfotooh, 1988

Interface Gap State Model With Applied Bias Voltage



$$\frac{\partial \Phi_{B,n}^o}{\partial V_a} = \frac{e^2 \delta_{gap} D_{GS} \varepsilon_{gap}^{-1}}{1 + e^2 \delta_{gap} D_{GS} \varepsilon_{gap}^{-1}}$$

$$n \equiv \left[1 - \frac{\partial \Phi_{Bn}^o}{e \partial V_a} \right]^{-1}$$

$$= 1 + e^2 \delta_{gap} D_{GS} \varepsilon_{gap}^{-1}$$

Fixed Separation Model: Internal Inconsistency

Predictions of Fixed Separation Model

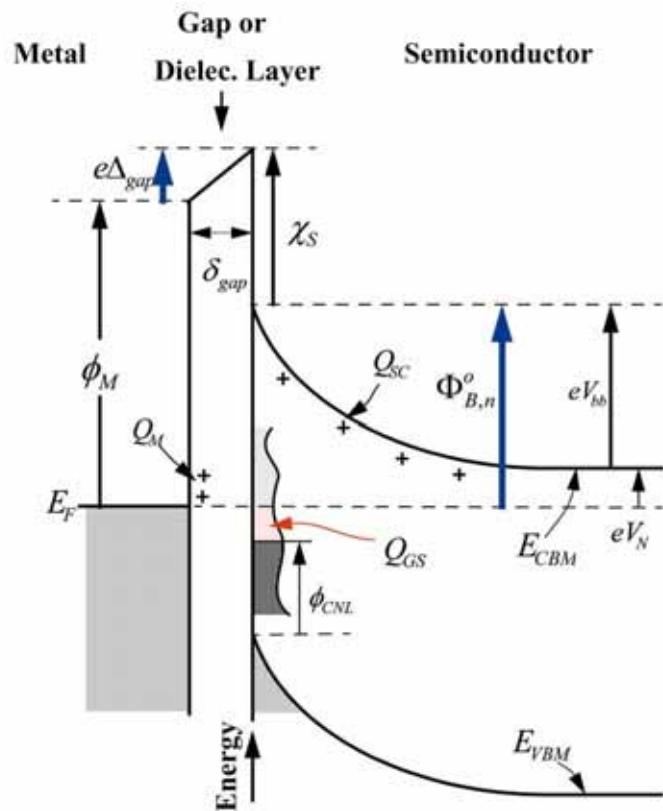
$$S_{\Phi} = \left(1 + e^2 \delta_{gap} D_{GS} \varepsilon_{gap}^{-1}\right)^{-1}$$

$$n = S_{\Phi}^{-1}$$
$$n = 1 + e^2 \delta_{gap} D_{GS} \varepsilon_{gap}^{-1}$$

But for most semiconductors,

$$n \approx 1 \quad S_{\Phi} < 0.3 \quad \Rightarrow \quad n \ll S_{\Phi}^{-1}$$

Interface Gap States: Fixed Separation Model



$$\Phi_{B,n}^o = \phi_M - \chi_S + e\Delta_{gap}$$

||

$$(\phi_{CNL} - \Phi_{B,n}^o) \frac{e^2 D_{gs} \delta_{gap}}{\epsilon_{gap}}$$

$$\Phi_{B,n}^o = \gamma_{GS}(\phi_M - \chi_S) + (1 - \gamma_{GS})(E_g - \phi_{CNL})$$

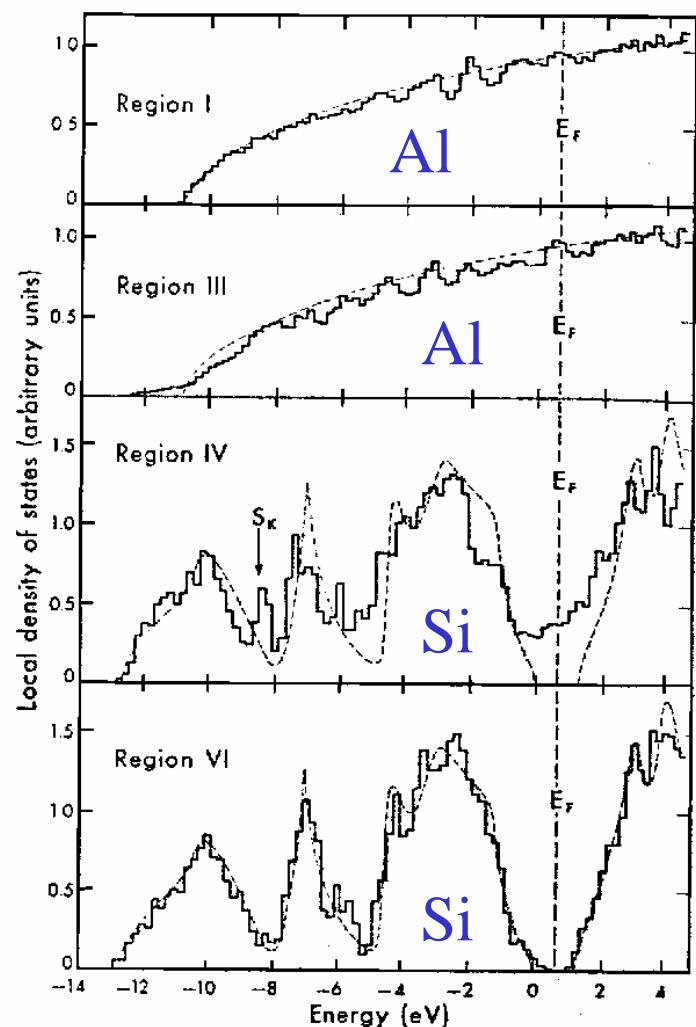
$$\gamma_{GS} = \left(1 + \frac{e^2 \delta_{gap} D_{GS}}{\epsilon_{gap}} \right)^{-1} \quad \longleftrightarrow \quad S_\Phi$$

Conditions for systematic analysis:

- (1) ~~Interface states are independent of the metal.~~
- (2) ~~Interface gap (distance) is large, > 1 nm.~~

Metal Induced Gap States (MIGS)

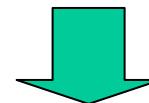
Louie 1977



MIGS penetration depth found to be:

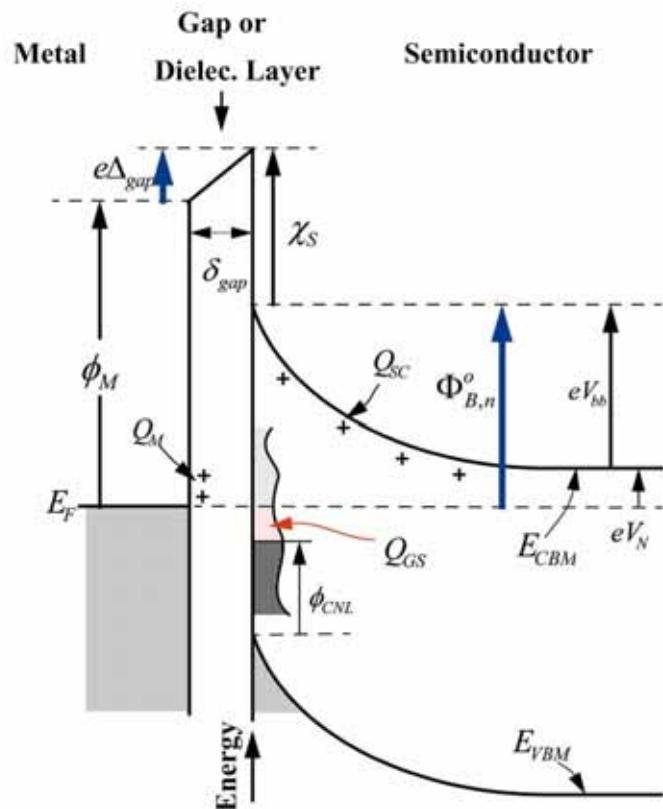
~0.1nm for ionic semiconductors

~0.3nm for covalent semiconductors



Charge transfer occurs over single atomic plane, i.e. bonding.

Interface Gap States: Fixed Separation Model



$$\Phi_{B,n}^o = \phi_M - \chi_S + e\Delta_{gap}$$

||

$$(\phi_{CNL} - \Phi_{B,n}^o) \frac{e^2 D_{gs} \delta_{gap}}{\epsilon_{gap}}$$

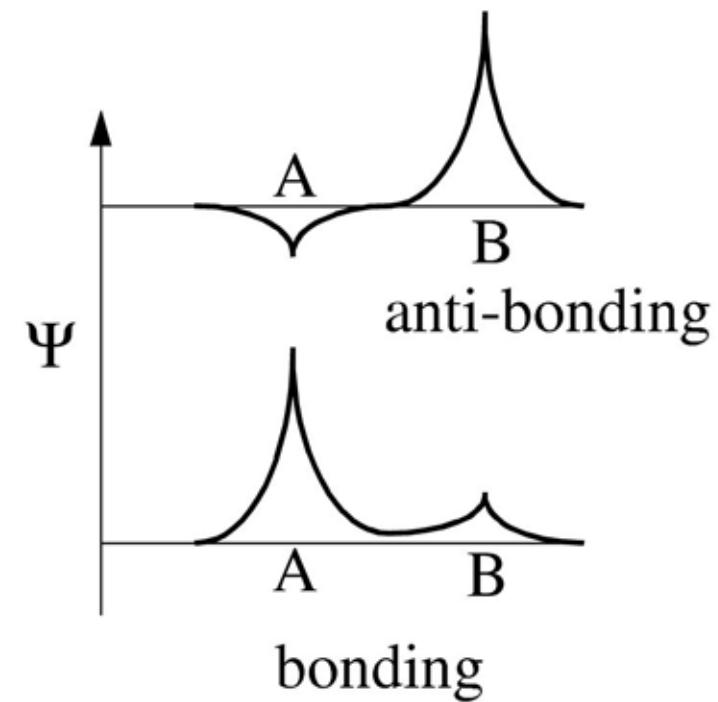
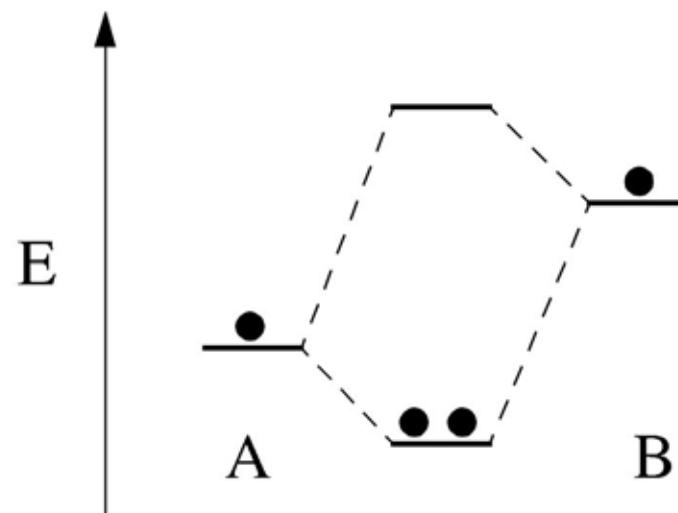
$$\Phi_{B,n}^o = \gamma_{GS}(\phi_M - \chi_S) + (1 - \gamma_{GS})(E_g - \phi_{CNL})$$

$$\gamma_{GS} = \left(1 + \frac{e^2 \delta_{gap} D_{GS}}{\epsilon_{gap}} \right)^{-1} \quad \leftrightarrow \quad S_\Phi$$

Conditions for systematic analysis:

- (1) ~~Interface states are independent of the metal.~~
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Simple Picture of Bond Polarization



Electrochemical Potential Equalization Method

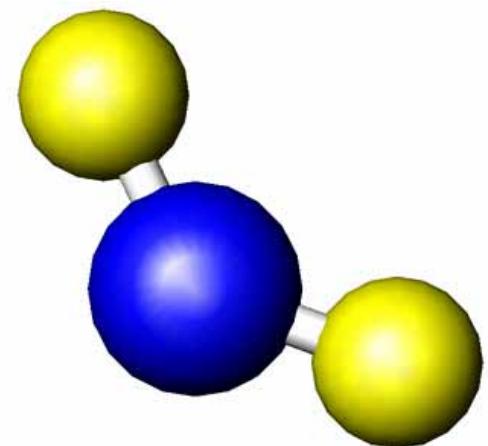
total energy of a multi-atomic molecule

$$E_{tot}(Q_A, Q_B, \dots, Q_N) = \sum_{i=A}^N (E_i^o + U_i Q_i + Y_i Q_i^2 / 2 + \dots) + \sum_{i \neq j} \frac{Q_i Q_j J_{ij}}{2}$$

$$U_A = \frac{\chi_A + I_A}{2} \quad \chi : \text{electron affinity}$$

I : ionization potential

$$Y_A = I_A - \chi_A \quad Q_A : \text{net charge on atom A}$$



minimize the energy, subject to $\sum_{i=A}^N Q_i = 0$

$$\mu_A = \frac{\partial E_{tot}}{\partial Q_A} \quad \text{electrochemical potential} \quad \mu_A = \mu_B = \dots = \mu_N$$

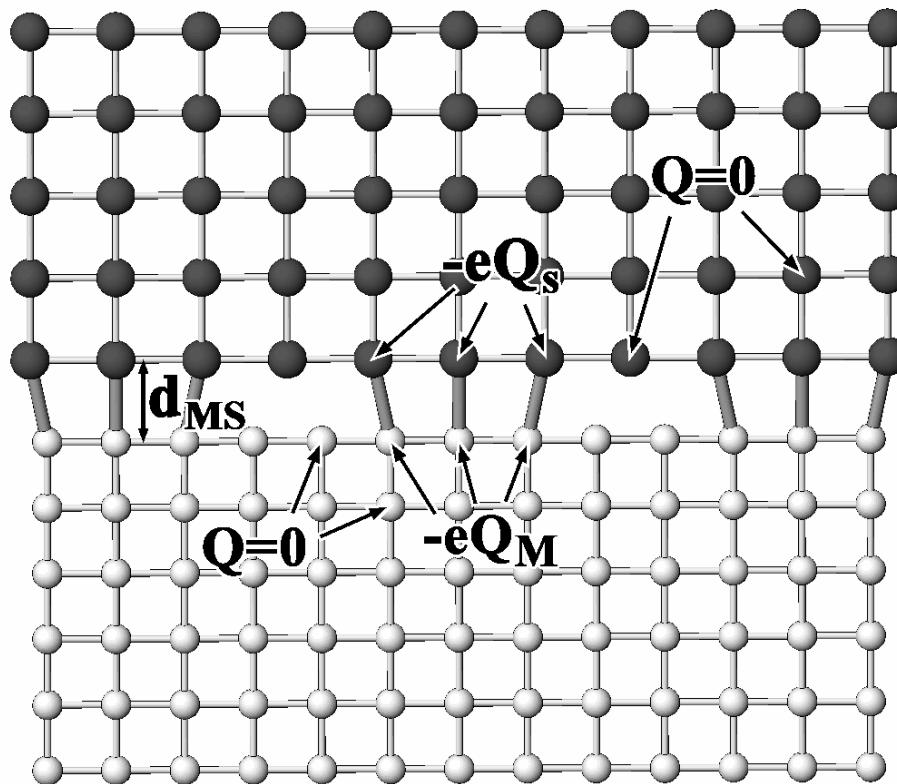
to get Q_A, Q_B, \dots, Q_N

Treating A Metal-Semiconductor Interface As A Gigantic Molecule

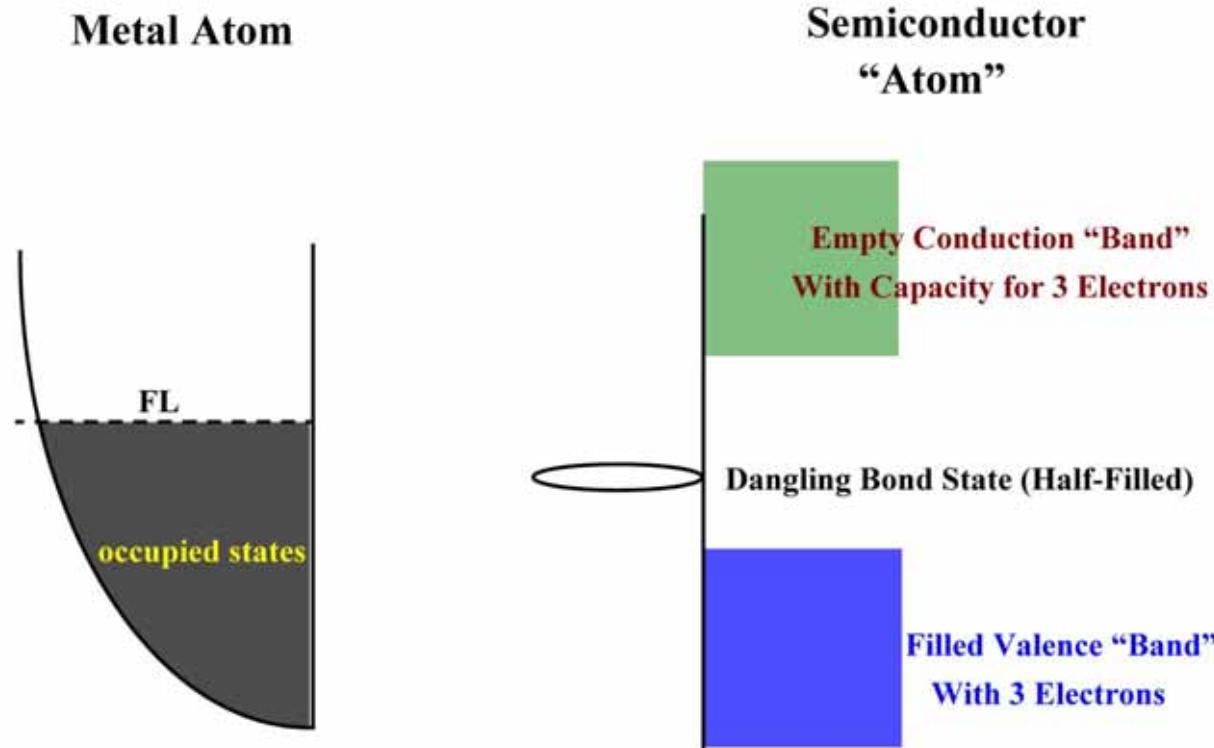
Assume bond density, N_B

Assume charge transfer
only for these bonds

Assume bond polarization
is interface dipole



Metal-Semiconductor Interface Bonds



First, break bonds!

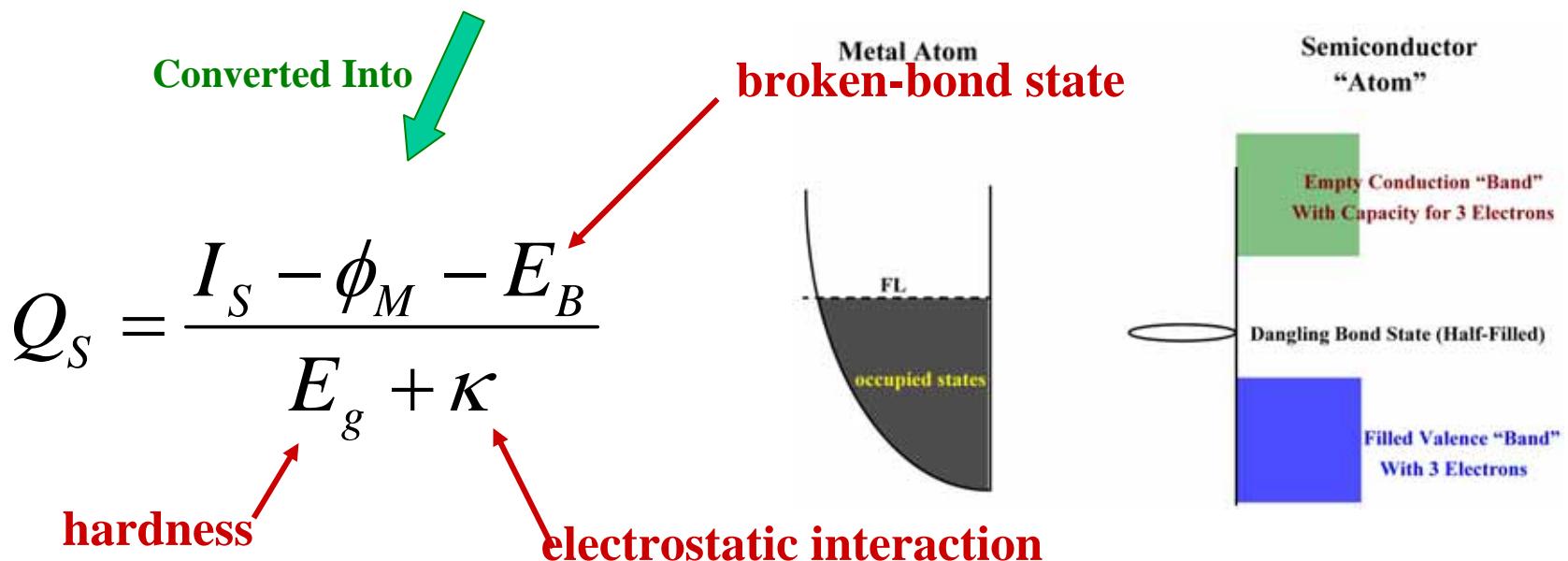
Bond Polarization At MS Interfaces

TOTAL ENERGY

$$E_{ISR} = \sum_i^{N_M} (E_M^o + U_M Q_{M_i} + \frac{1}{2} Y_M Q_{M_i}^2) + \sum_i^{N_S} (E_S^o + U_S Q_{S_i} + \frac{1}{2} Y_S Q_{S_i}^2) \\ + \sum_{i \neq j}^{N_M} \frac{Q_{M_i} Q_{M_j} J_{M_i M_j}}{2} + \sum_{i \neq j}^{N_S} \frac{Q_{S_i} Q_{S_j} J_{S_i S_j}}{2} + \sum_{i,j}^{N_M, N_S} Q_{M_i} Q_{S_j} J_{M_i S_j}$$

CHARGE TRANSFER

$$Q_S = \frac{U_M - U_S}{Y_S + Y_M - 2J_{MS} + 4J_{MM} + 4J_{SS}}$$



Bond Polarization At MS Interfaces

$$\Phi_{B,n}^o = \gamma_B (\phi_M - \chi_S) + (1 - \gamma_B)(E_g - E_B)$$

$$\gamma_B = 1 - \frac{e^2 N_B d_{MS}}{\epsilon_{it}(E_g + \kappa)}$$

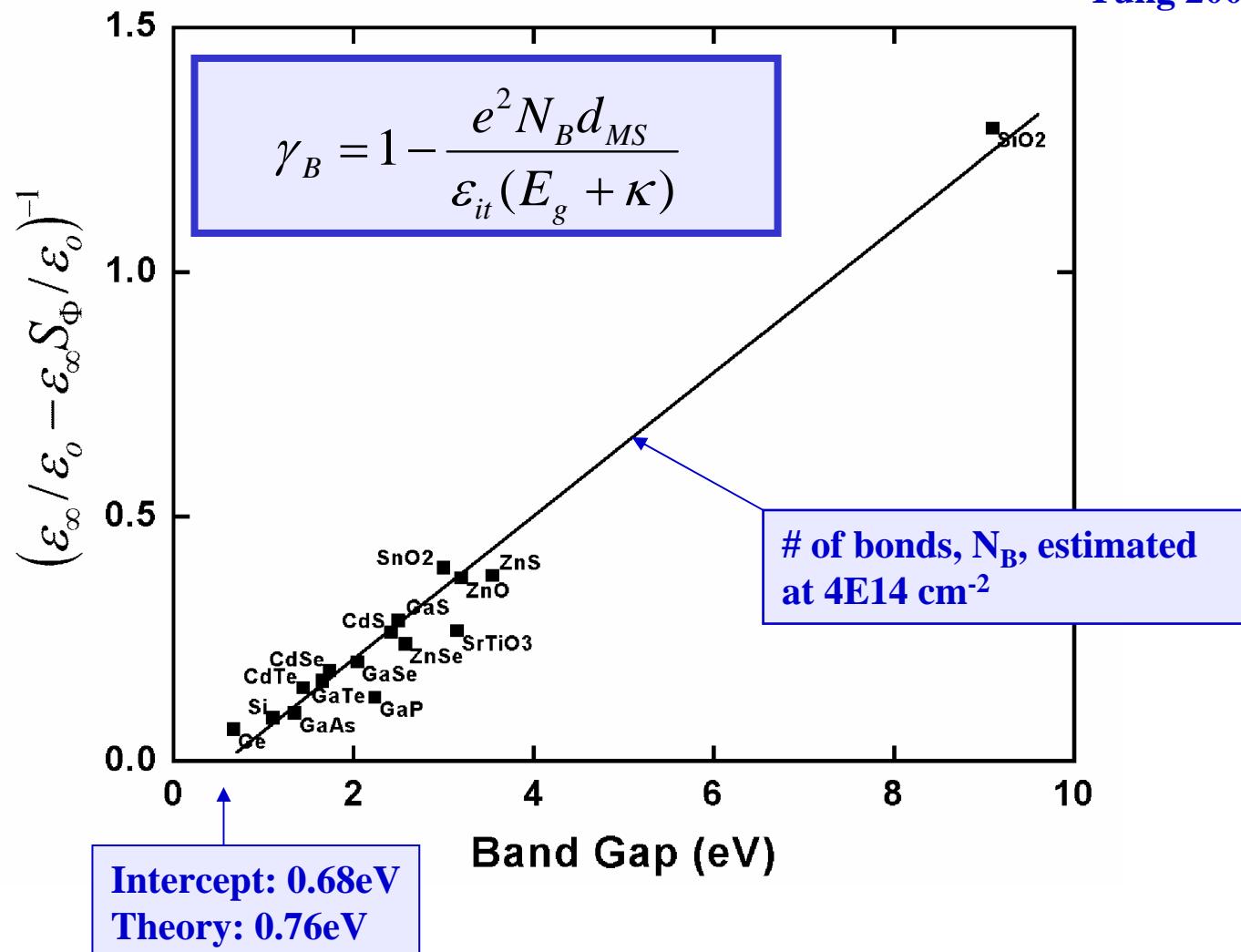
Interface gap states model :

$$\Phi_{B,n}^o = \gamma_{GS} (\phi_M - \chi_S) + (1 - \gamma_{GS})(E_g - \phi_{CNL})$$

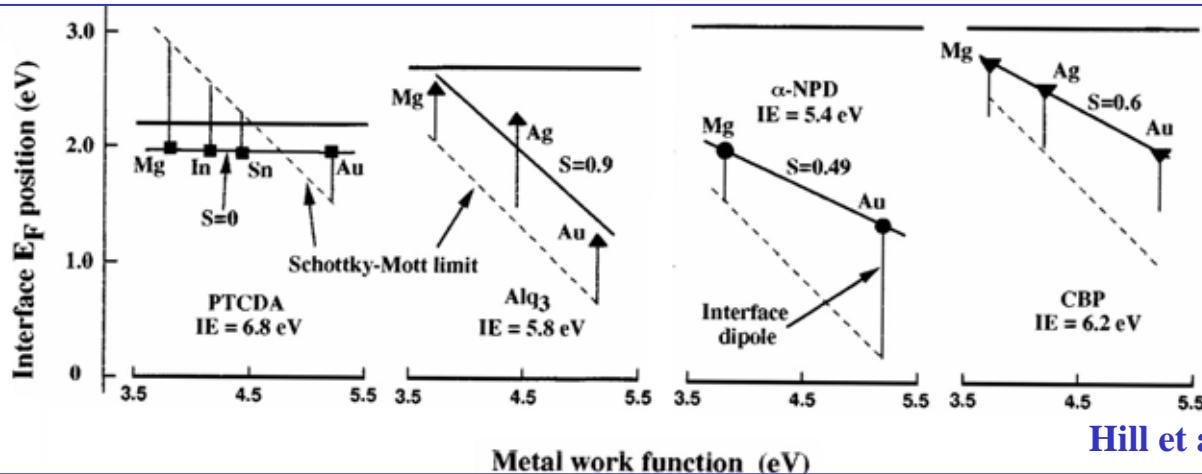
$$\gamma_{GS} = \left(1 + \frac{e^2 \delta_{gap} D_{GS}}{\epsilon_{gap}} \right)^{-1}$$

Bond Polarization Theory Of SBH

Tung 2000

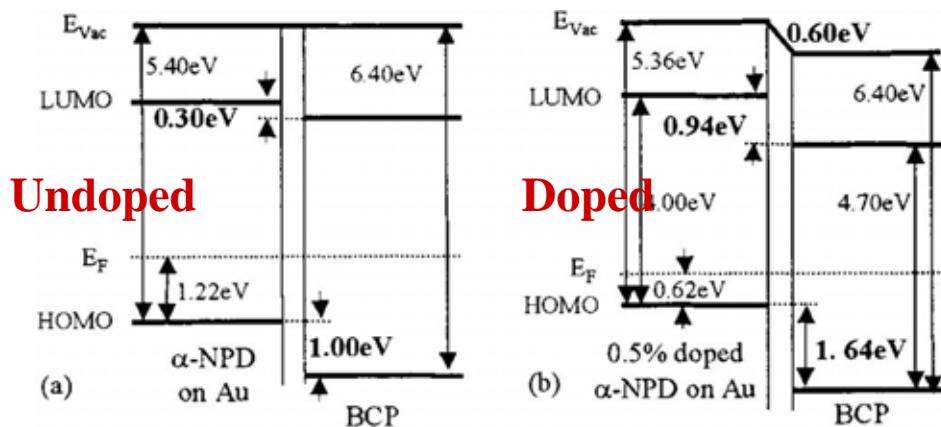


“Band”-Alignment At Organic Interfaces



Metal-Organic

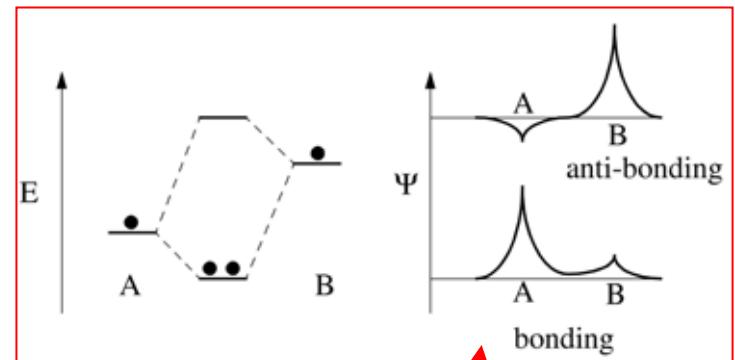
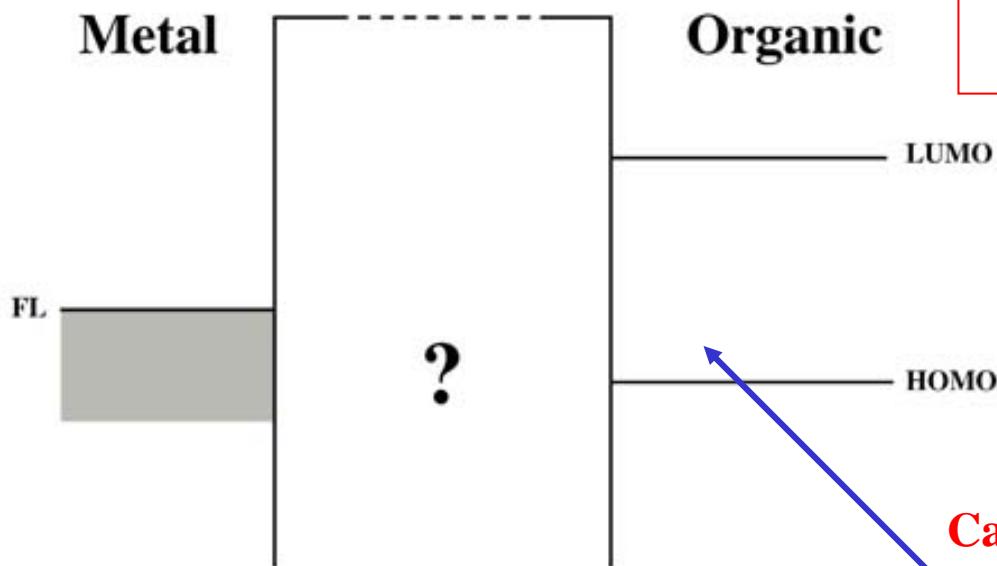
Hill et al., APL 73, 662 (1998)



Organic-Organic

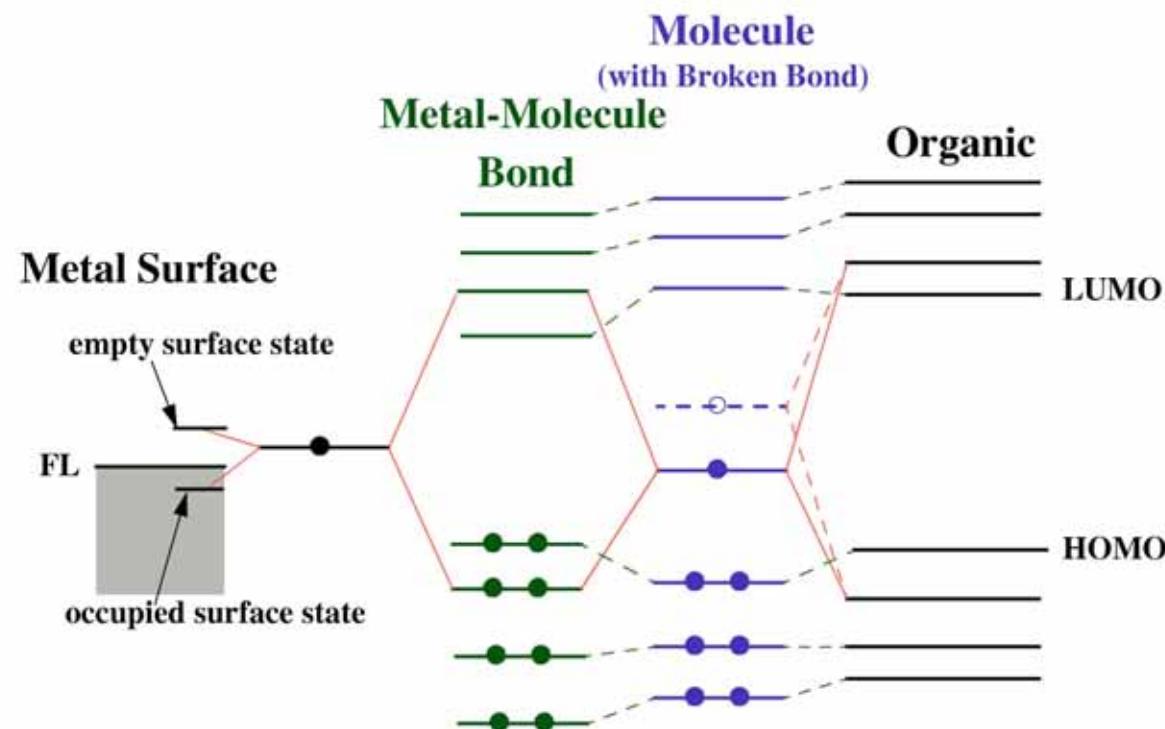
Gao & Kahn, APL 82, 4815 (2003).

Interface Dipole At Organic Interface

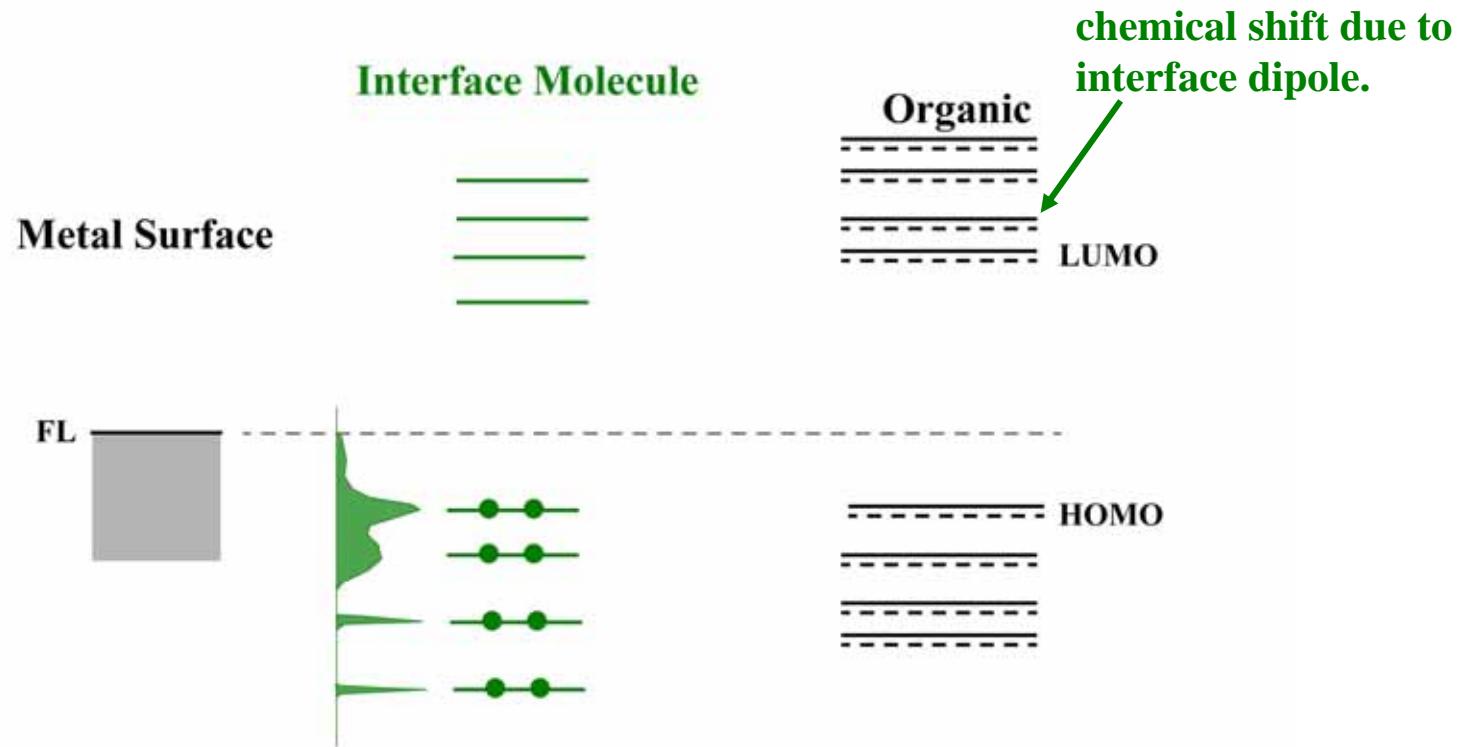


Can't use this bonding picture,
because there're no unpaired
electrons on perfect molecules!

The FBTB Picture of Interface Dipole Formation



The FBTFB Picture of Interface Dipole Formation



$$\Phi_{hole} = \gamma_B (I - \phi_M) + (1 - \gamma_B) E_B$$

$$\gamma_B = 1 - \frac{e^2 N_B d_{it}}{\varepsilon_{it} (E_H + \kappa)}$$

First-Break-Then-Form-Bond (FBTFB) Picture of Interface Dipole Formation

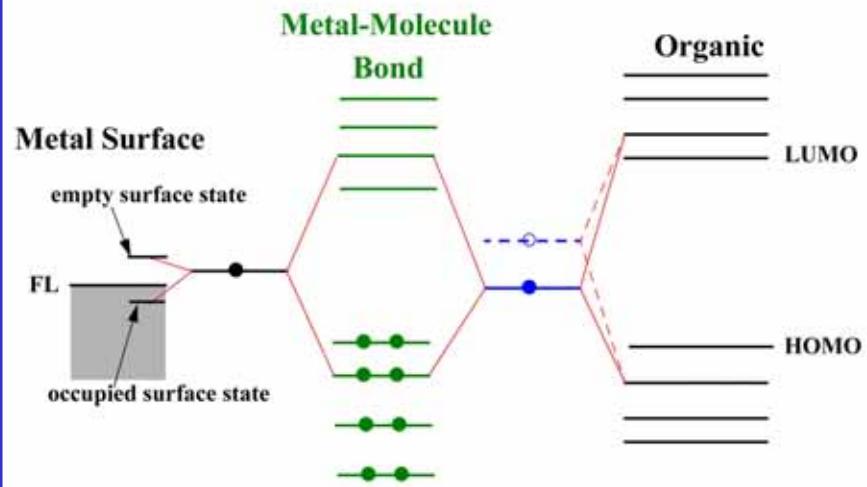
SALIENT FEATURES

Apparent pinning at orbital energy of the bond which has been broken.

No interface gap states needed to pin the Fermi level.

Bonding configuration matters.

Metal states matter.



$$\Phi_{hole} = \gamma_B (I - \phi_M) + (1 - \gamma_B) E_B$$

CAVEATS

Change in work function associated with bond breaking has been neglected.
Polarization of molecule has been neglected.

Different bonding configurations for different interfaces (different metals).
More than one bonding configurations possible at one interface.